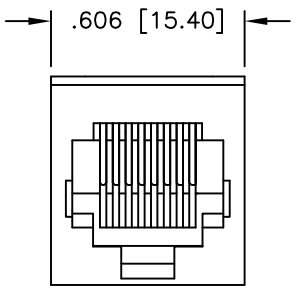
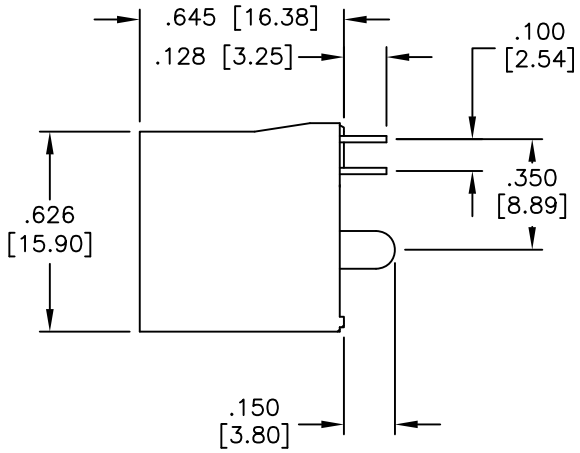
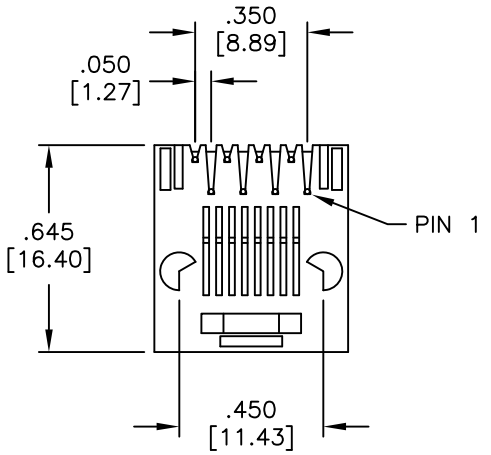
APPROVED: _____

DATE: _____ TITLE: _____

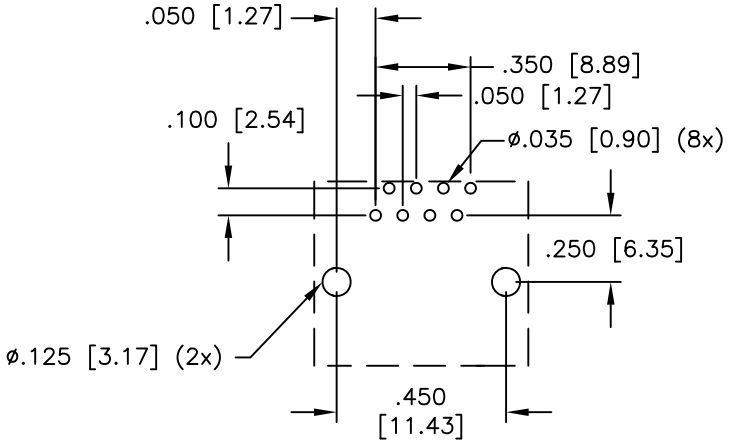
Rev	AWO #	Description	Date	Appr
-		RELEASED	3/27/09	
A		UPDATED SPECIFICATIONS	5/5/17	







X	PLATING
0	15 µin Gold
1	30 µin Gold
2	50 µin Gold



RECOMMENDED PCB LAYOUT

SPECIFICATIONS:

Material:

Insulator: PBT, rated UL 94V–0

Insulator color: Black

Contacts: .017" [0.45mm] Dia. Round, Phosphor Bronze

Plating:

Gold over Nickel underplate on contact area, Tin over Copper underplate on PCB tails

Electrical:

Operating voltage: 150 VAC max

Current rating: 1.5 Amps max

Contact resistance: 20 mohms max

Insulation resistance: 500 Mohms min @ 500 VDC

Dielectric withstanding voltage: 1000 VAC for 1 minute

Temperature Rating:

Operating temperature: –40°C to +125°C

Environmental:

Lead free, RoHS compliant.

Recommended soldering temp: 235°C for 5 sec. RoHS COMPLIANT

UNLESS OTHERWISE SPECIFIED
ALL DIMENSIONS ARE INCHES [MM]
TOLERANCES: EXCEPT AS NOTED

INCHES		HOLES	
.X	± .10	Ø.X	±.10
.XX	± .020	Ø.XX	±.015
.XXX	± .015	Ø.XXX	±.010

APPROVALS		DATE
DRAWN	SS	3/27/09
CHECKED		
APPROVED		

METABEE

TITLE: MODULAR TELEPHONE JACK, 8P8C, TOP ENTRY
MOON PEG, NO STOPS, ROUND PCB CONTACTS

SIZE	PART NO.	REV.
X	MTJ-883X1-N-MP	A

REF: | SCALE: NTS | SHEET 1 OF 1